18 Non-sinusoidal Signal

19 Spread Spectrum Techniques20 Optical and Ultrasonic Application

Preliminary Announcement

1984 INTERNATIONAL SYMPOSIUM ON ELECTROMAGNETIC COMPATIBILITY IECE & IEE OF JAPAN IEEE EMC-S

OCTOBER 16 - 18, 1984/TOKYO

Symposium and Technical Exhibitions will be held at Hotel Pacific/Tokyo.

Suggested topic categories include, but not limited to the followings:

1 Noise, Sprious and Harmonics

2 Contacts and Gap Discharge

Phenomena

3	 3 Lightning Surge, EMP and ESD 4 EM Field and Lines/ Coupling and Crosstalk 5 Scattering, TV Ghost Problem and Radar False Echoes 6 EM Wave Propagation and Fading 7 EM Environments 8 Interference and Damages 9 Noise and EM Field Measurement 			EMC in			
4				1	Communication and Automation		
5				•	Systems		
				2	Instrumentation		
.6				3	CPU/VLSI		
7				24	Radio Navigation/Aerospace		
8				25 Mobile Communication			
9				6	Consumer Products		
	and Analysis		2	7	Micro Electronics		
	EM Sensor, Probe a		28	3	Transportation		
11	11 Shielding and Grounding/ Technique and Material			9	High Energy Generation		
12	12 EM Energy Absorber/ Unechoic Material)	Mines		
13	13 Filter, Transformer and			1 Spec	etrum Economy and Management		
	Isolator		32		dard, Regulation, Limit and		
14	EMI/EMC Test	¥ .		Spec	cification		
15	Immunity and Susce	ptibility	33	3 EMC	C Education		
16	Biological Effects		34	1 Othe	ers		
17	Hyperthermia						
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		1 2 3	3 4 5 6	7 8	9 10 11 12 13 14 15 16 17		
	I will attend the Sy	mposium. 18 19 2	0 21 22 23 2	24 25	26 27 28 29 30 31 32 33 34		
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